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# **FDP7N60NZ / FDPF7N60NZ** N-Channel UniFET<sup>TM</sup> II MOSFET 600 V, 6.5 A, 1.25 Ω

#### Features

- $R_{DS(on)}$  = 1.05  $\Omega$  (Typ.) @ V<sub>GS</sub> = 10 V, I<sub>D</sub> = 3.25 A
- Low Gate Charge (Typ. 13 nC)
- Low C<sub>rss</sub> (Typ. 7 pF)
- 100% Avalanche Tested
- Improved dv/dt Capability
- ESD Improved Capability
- RoHS Compliant

#### Applications

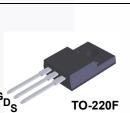
- LCD/ LED/ PDP TV
- Lighting
- Uninterruptible Power Supply

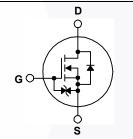
GDS

AC-DC Power Supply

## Description

UniFET<sup>TM</sup> II MOSFET is Fairchild Semiconductor's high voltage MOSFET family based on advanced planar stripe and DMOS technology. This advanced MOSFET family has the smallest on-state resistance among the planar MOSFET, and also provides superior switching performance and higher avalanche energy strength. In addition, internal gate-source ESD diode allows UniFET II MOSFET to withstand over 2kV HBM surge stress. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp balasts.





#### MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

**TO-220** 

Symbol		FDP7N60NZ	FDPF7N60NZ/ FDPF7N60NZT	Unit			
V <sub>DSS</sub>	Drain to Source Voltage			6	V		
V <sub>GSS</sub>	Gate to Source Voltage			±	V		
ID	Drain Quarant	- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)		6.5	6.5*	•	
	Drain Current	- Continuous (T <sub>C</sub> = 100 <sup>o</sup> C)		3.9	3.9*	A	
DM	Drain Current	- Pulsed	(Note 1)	26	26*	А	
E <sub>AS</sub>	Single Pulsed Avalanche Energy		(Note 2)	275		mJ	
AR	Avalanche Current		(Note 1)	6.5		А	
E <sub>AR</sub>	Repetitive Avalanche Energy		(Note 1)	14.7		mJ	
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	10		V/ns	
P <sub>D</sub>	Deven Dissingtion	$(T_{C} = 25^{\circ}C)$		147	33	W	
	Power Dissipation	- Derate Above 25°C		1.2	0.26	W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 te	°C		
TL	Maximum Lead Temperature	3	°C				

#### Drain current limited by maximum junction temperature.

### Thermal Characteristics

Symbol	Parameter	FDP7N60NZ	FDPF7N60NZ / FDPF7N60NZT	Unit	
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.85	3.8	°C/W	
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	62.5	C/W	

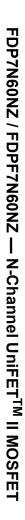
December 2013

Part Number		Top Mark	Package	Packing Method	Reel Size	e 1	Tape Width	Qu	Quantity	
FDP7N60NZ		FDP7N60NZ	TO-220	Tube	N/A		N/A	50	50 units	
FDPF7N60NZ		FDPF7N60NZ	TO-220F	Tube	N/A		N/A		50 units	
FDPF7N60NZT FDPF7N60NZ		TO-220F	D-220F Tube N/A			N/A		50 units		
Electrica	l Chara	cteristics T <sub>C</sub> = 25°C	c unless of	herwise noted.						
Symbol		Parameter		Test Condition	ns	Min.	Тур.	Max.	Unit	
Off Charac	teristics									
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage		Ir	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 25 <sup>o</sup> C			-	-	V	
ΔBV <sub>DSS</sub> /ΔTJ	Breakdown Voltage Temperature			$I_D = 250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$			0.6	-	V/ºC	
-	Zoro Cot	o Voltago Drain Current	V	<sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V		-	-	1		
DSS	Zero Gat	e Voltage Drain Current	V	<sub>DS</sub> = 480 V, T <sub>C</sub> = 125°0	C	-	-	10	μA	
GSS	Gate to E	Body Leakage Current	V	$G_{\rm GS}$ = ±25 V, V <sub>DS</sub> = 0 V		-	-	±10	μA	
On Charac	teristics									
V <sub>GS(th)</sub>	Gate Thr	eshold Voltage	V	′ <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μA		3	-	5	V	
R <sub>DS(on)</sub>	Static Drain to Source On Resistance			V <sub>GS</sub> = 10 V, I <sub>D</sub> = 3.25 A			1.05	1.25	Ω	
9 <sub>FS</sub>	Forward Transconductance			V <sub>DS</sub> = 20 V, I <sub>D</sub> = 3.25 A			7.3	-	S	
Dynamic C	haracter	ristics								
C <sub>iss</sub>	Input Capacitance					-	550	730	pF	
C <sub>oss</sub>	Output C	apacitance		— V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, — f = 1 MHz		-	70	90	pF	
C <sub>rss</sub>	Reverse	Transfer Capacitance	1	1 = 1 MHZ		-	7	10	pF	
Q <sub>g(tot)</sub>	Total Gat	e Charge at 10V	V	V <sub>DS</sub> = 480 V, I <sub>D</sub> = 6.5 A, V <sub>GS</sub> = 10 V		-	13	17	nC	
Q <sub>gs</sub>	Gate to S	ource Gate Charge				-	3	-	nC	
Q <sub>gd</sub>	Gate to D	Prain "Miller" Charge			(Note 4)	-	5.6	-	nC	
Switching	Characte	eristics								
t <sub>d(on)</sub>	Turn-On	Delay Time				-	17.5	45	ns	
t <sub>r</sub>	Turn-On	Rise Time		$V_{DD}$ = 300 V, I <sub>D</sub> = 6.5 A, V <sub>GS</sub> = 10 V, R <sub>G</sub> = 25 Ω (Note 4)		-	30	70	ns	
t <sub>d(off)</sub>	Turn-Off I	Delay Time	V			-	40	90	ns	
-() f	Turn-Off I	Fall Time				-	25	60	ns	
)rain-Sou	ce Diod	e Characteristics	J				4		1	
s	Maximum Continuous Drain to Source Diode Forward Current			-	-	6.5	Α			
SM	Maximum Pulsed Drain to Source Diode			Forward Current			-	26	Α	
V <sub>SD</sub>	Drain to Source Diode Forward Voltage		age V	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 6.5 A			-	1.4	V	
m	Reverse Recovery Time			V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 6.5 A,			250	-	ns	
Q <sub>rr</sub>	Reverse I	Recovery Charge		I <sub>F</sub> /dt = 100 A/μs		-	1.4	-	μC	

2: L = 13 mH,  $I_{AS} = 6.5 \text{ A}$ ,  $V_{DD} = 50 \text{ V}$ ,  $R_G = 25 \Omega$ , starting  $T_J = 25^{\circ}\text{C}$ 

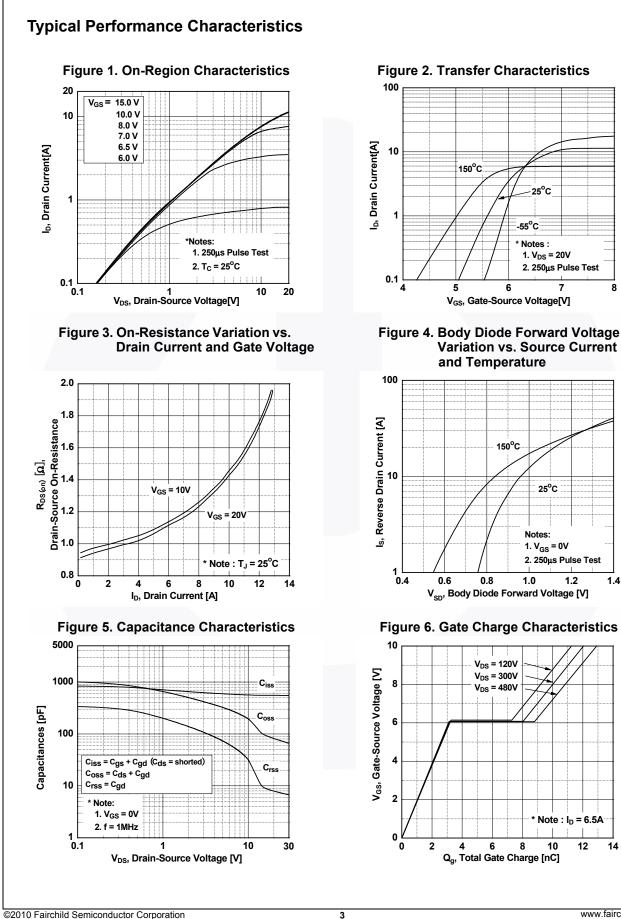
3:  $I_{SD} \le 6.5 \text{ A}$ , di/dt  $\le 200 \text{ A/}\mu\text{s}$ ,  $V_{DD} \le \text{BV}_{DSS}$ , starting  $T_J = 25^{\circ}\text{C}$ . 4: Essentially independent of operating temperature typical characteristics. FDP7N60NZ / FDPF7N60NZ — N-Channel UniFET<sup>TM</sup> II MOSFET

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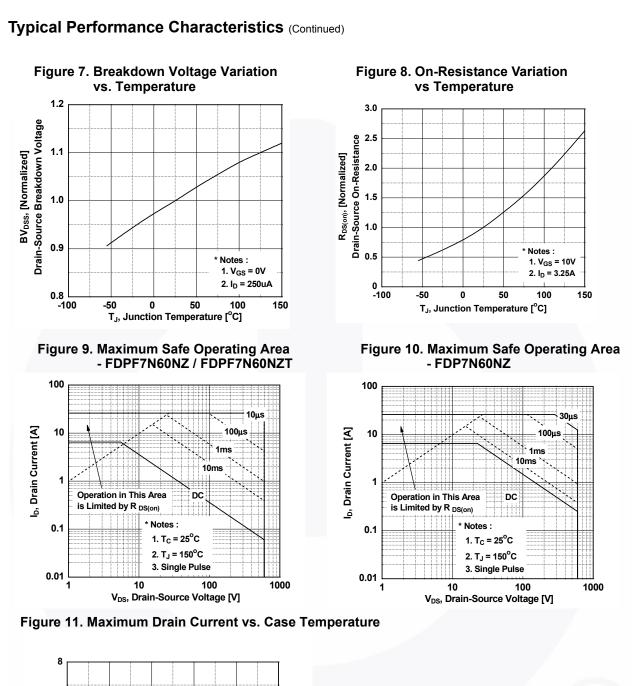
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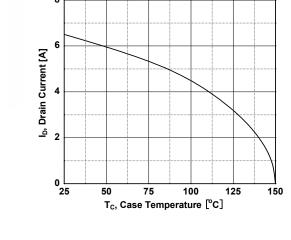
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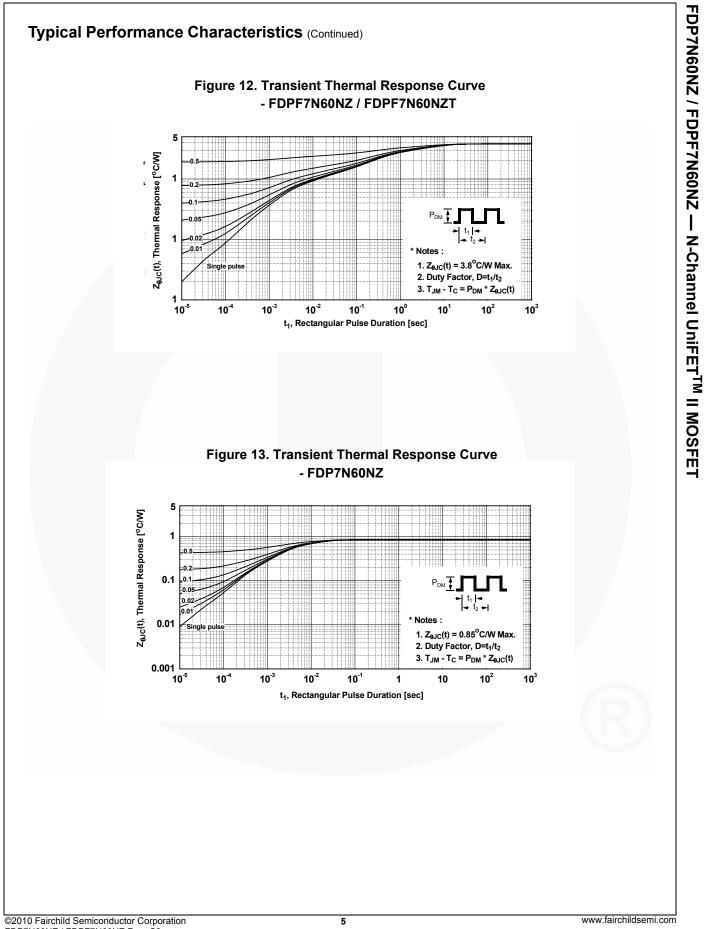


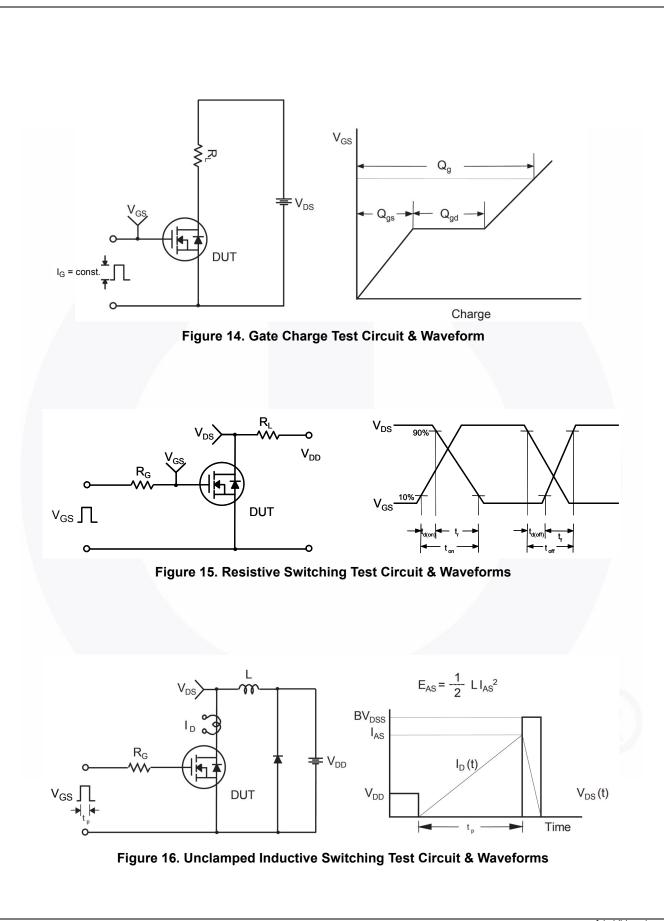
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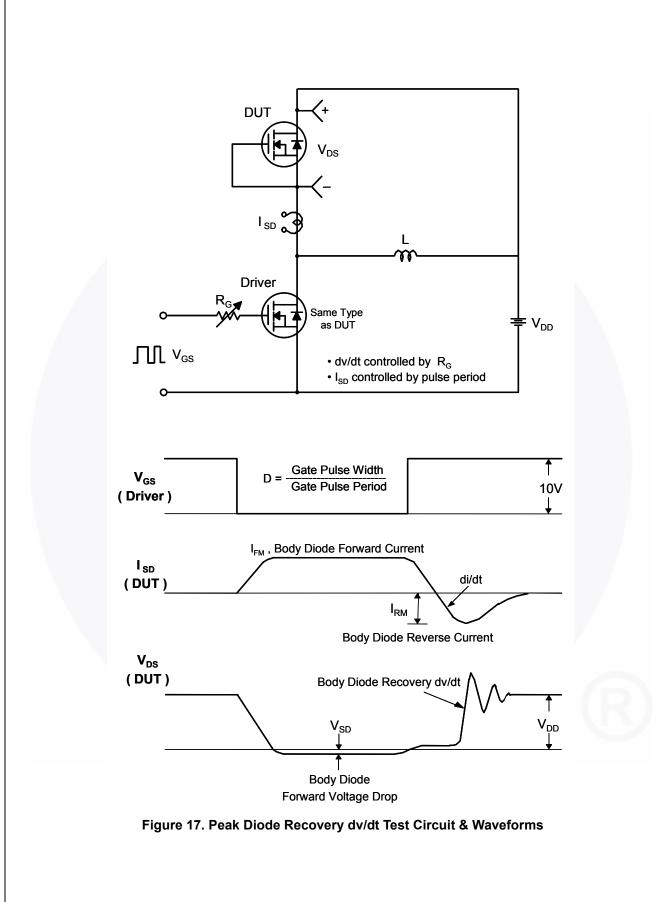
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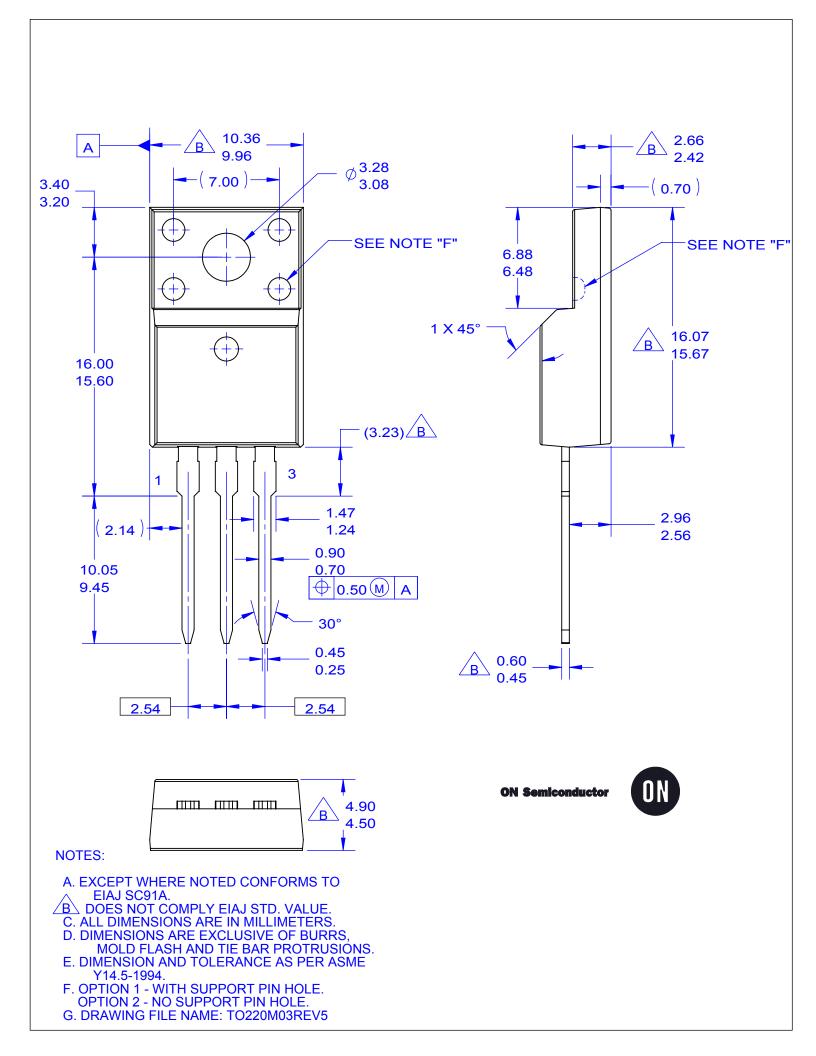






FDP7N60NZ / FDPF7N60NZ — N-Channel UniFET<sup>TM</sup> II MOSFET





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